

## ABSTRACT

A production method of an electronic device

5 comprising the steps of forming a stacked body by  
stacking green sheets 10a and electrode layers 12a having  
a predetermined pattern and firing the stacked body.  
Before forming the stacked body, a blank pattern layer 24  
having substantially the same thickness as that of the  
10 electrode layer is formed on a space portion of the  
electrode layer having a predetermined pattern. The  
electrode level difference absorbing print paste for  
forming the blank pattern layer 24 includes at least  
ceramic powder and a binder resin, and a polymerization  
15 degree of the binder resin included in the electrode  
level difference absorbing print paste is made equal to  
or more than that of a binder resin included in slurry  
for forming the green sheet. The binder resin of the  
electrode level difference absorbing print paste includes  
20 a polyvinyl butyral resin, a polymerization degree of the  
polyvinyl butyral resin is 1400 or more, a butyralation  
degree is 64 to 74 mol%, and an acetalization degree is  
66 to 74 mol%.